

# Testing of Thermal Interface Materials: Preliminary Observations

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# Introduction

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- Purpose of thermal interface materials:
  - ✓ enhance heat transfer at joint by reducing thermal contact resistance
  - ✓ provide better thermal contact between chip (source) and heat sink / spreader (sink)
- Applications:
  - ✓ heat sink attach
  - ✓ heat spreader attach
- Widely used in industry



# Introduction

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- Interface materials are divided into four categories:
  - ✓ greases and liquids
  - ✓ compliant materials: deform more than 10% under clamping force
  - ✓ hard rubber materials: deform less than 10% under clamping force
  - ✓ thermally conductive materials: materials such as ceramics and plastics that require high clamping force



# Objectives

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- Design and construct apparatus for thermal testing of interface materials
- Measure joint resistance and thermal conductivity as function of
  - ✓ temperature
  - ✓ contact pressure
  - ✓ material properties
  - ✓ surface characteristics



# Measurement Procedure



- Joint resistance and conductivity calculated based on temperature and thickness measurements

- Thermal joint resistance

$$R_{\text{joint}} = \frac{\Delta T_{\text{joint}}}{Q}$$

$\Delta T_{\text{joint}}$  = joint temperature drop

$Q$  = total heat flow rate

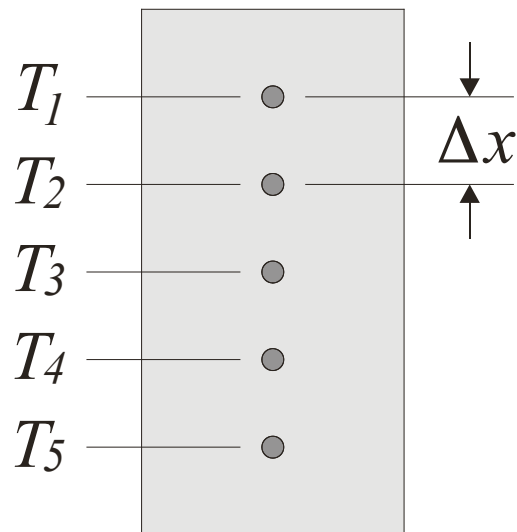
- Thermal conductivity

$$k = \frac{1}{R_{\text{joint}}} \frac{t_{\text{joint}}}{A_{\text{joint}}}$$

$t_{\text{joint}}$  = joint thickness

$A_{\text{joint}}$  = joint cross-sectional area

# Heat Flux Meter



- Isotropic, constant cross section cylinders of known conductivity,  $k = f(T)$
- Dual-purpose device
  - ✓ calculate heat flow rate
  - ✓ determine joint temperatures
- Temperature gradient measured by RTDs
  - ✓ accuracy  $< 0.1 \text{ }^\circ\text{C}$
  - ✓ equal spacing –  $10 \text{ mm}$

# Heat Flux Meter



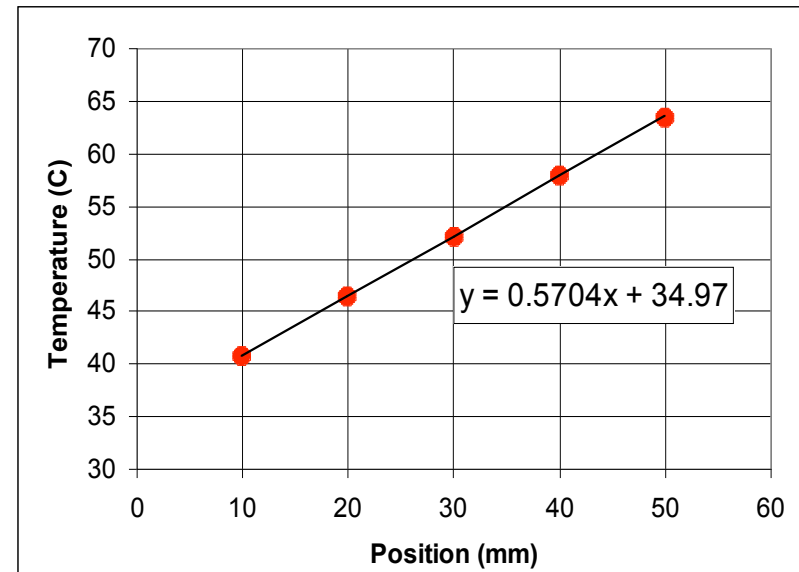
- Heat flow rate:

$$Q = k A \frac{dT}{dx}$$

- Temperature gradient from linear fit of temperature data

$$\frac{dT}{dx} = m$$

- Total heat flow rate = average of upper and lower flux meters



# Heat Flux Meter



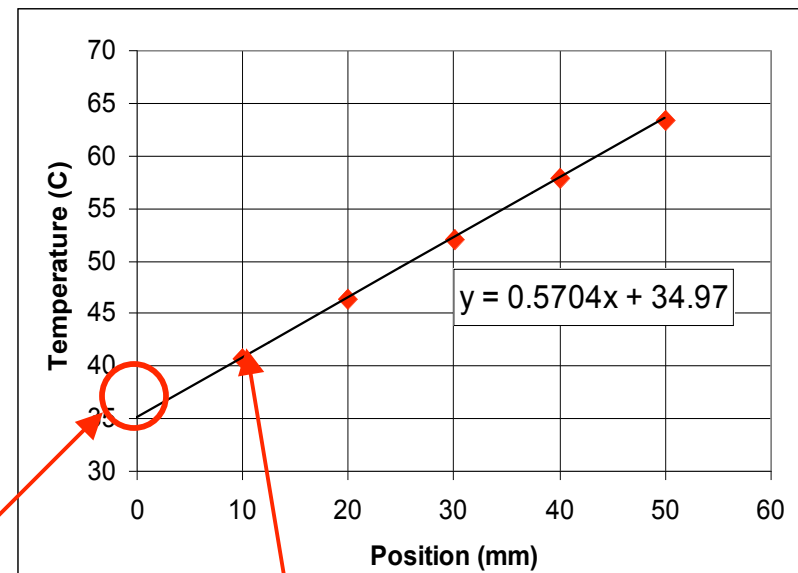
- Joint temperature determined by extrapolating temperature gradient to the joint surface

$$T_{\text{joint}} = T_{\text{last}} + \frac{dT}{dx} \cdot \Delta x$$

- Joint temperature drop

$$\Delta T_{\text{joint}} = T_{\text{joint,lower}} - T_{\text{joint,upper}}$$

*Extrapolated  
Joint Temperature*



$T_{\text{last}}$



# Apparatus



- All testing performed in vacuum chamber
  - ✓  $P \approx 10 Pa$  ( $1 \times 10^{-4} atm$ )
  - ✓ remove heat losses due to convection
  - ✓ maintain close balance between flux meters

# Apparatus



## Testing of thermal grease with 0.003" shim

*Thrust Bearing*

*Cooling Block*

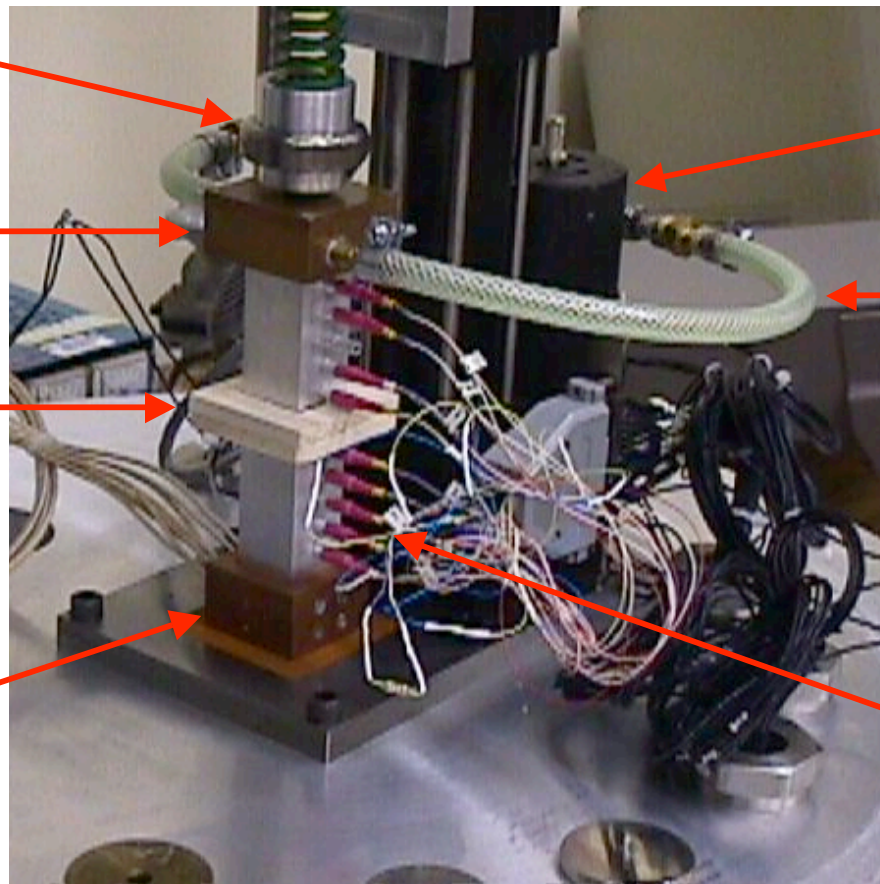
*Shim*

*Heater Block*

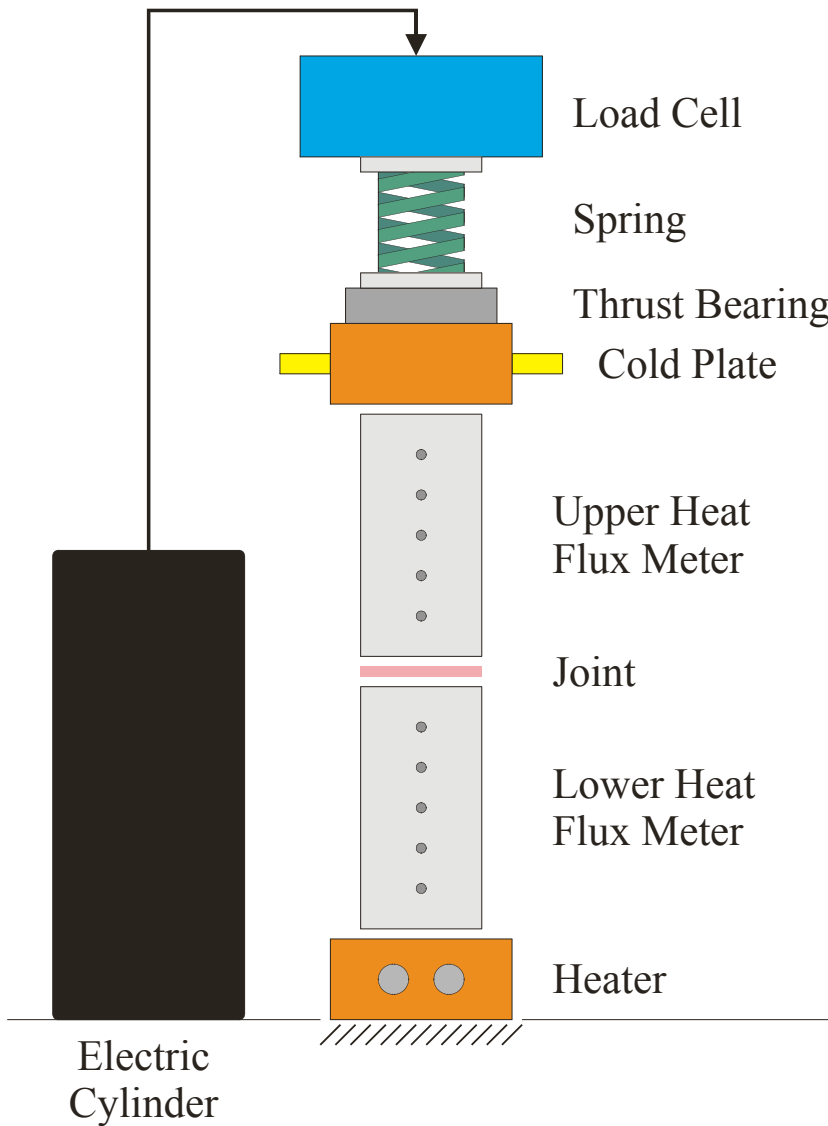
*Electric Cylinder*

*Coolant Supply  
Tubing*

*RTDs*

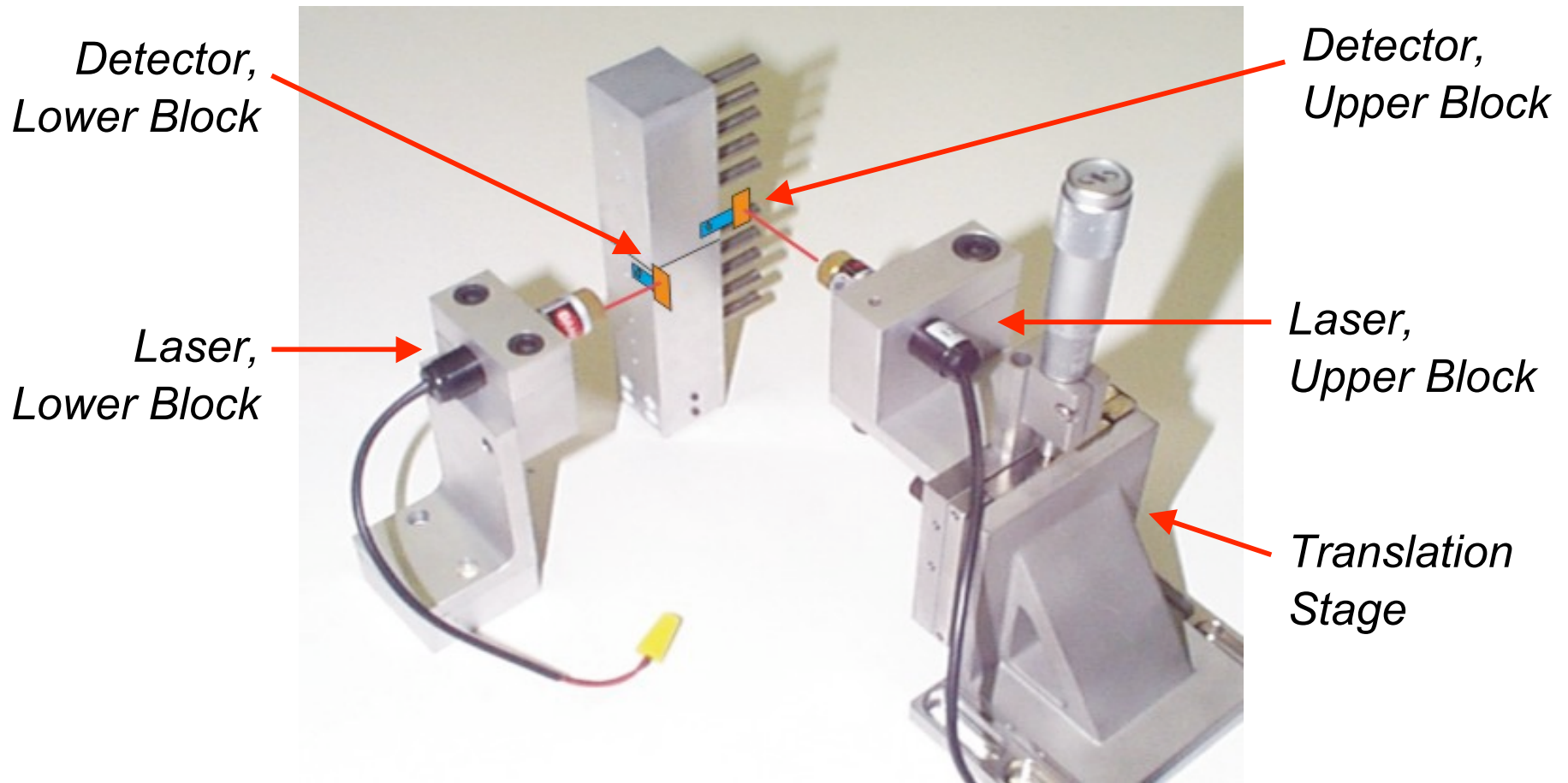


# Apparatus



- Load cell
  - ✓ 100 or 1000 lbs
- Spring to compensate for thermal expansion
- Thrust bearing to remove torque loads
- Electric cylinder
  - ✓ digitally controlled stepper motor
  - ✓ 400 steps / rev 0.1" per revolution

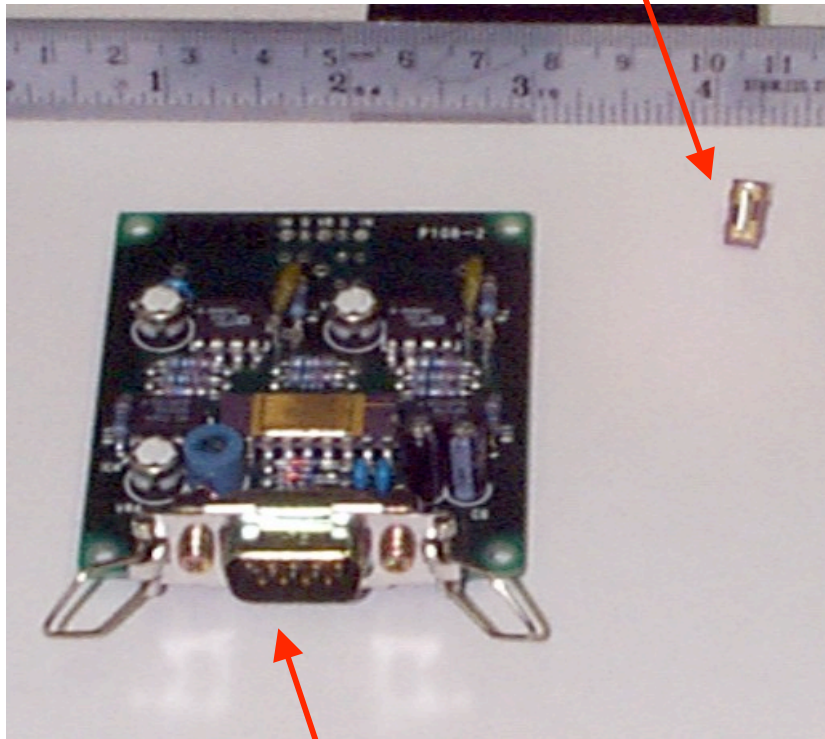
# Thickness and Deflection



# Thickness and Deflection



*Detector*



*Signal  
Processing  
Card*

## ■ Lasers

✓ *5 mW*

✓ *670 nm* wavelength

✓ *100 μm* at 4" colimation

## ■ Detectors